

Design of Radiation Hardened RADFET Readout System for Space Applications

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15.07.2020 Virtual ELICSIR workshop





innovations for high performance microelectronics



1 Motivation

- 2 Contribution
- 3 RADFET Dosimetry
- 4 Rad-hard Readout System Design
- 5 Analog Signal Conditioner
- 6 Self-Adaptive Multiprocessor System-on-Chip

7 Conclusion

2



The concept outlined in this presentation has been accepted for publication at Euromicro Conference on Digital Systems Design (DSD), 2020

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"Design of Radiation Hardened RADFET Readout System for Space Applications"

1. Motivation



Space radiation environment

- Complex (wide range of sources and energies)
- Dynamic (variable radiation intensity)

Radiation effects

- Lethal for humans
- Source of failures in electronics
 - Total Ionizing Dose (TID) effects
 - Single Event Effects (SEEs)

Galactic cosmic rays (H, He-Fe-nuclei.....) Mars Large solar proton flares Geomagnetically trapped radiation (protons, electrons)

Moo

Space mission requirements

- Radiation dosimetry adsorbed dose and dose rate measurement
- Radiation-hardened electronics robust to TID and SEEs

[Illustration from https://www.nasa.gov]



Common radiation dosimeters in space applications

- > Diodes measure dose rate in terms of radiation-induced current
- RADFETs measure absorbed dose in terms of threshold voltage shift

RADFET's advantages

- Operation in passive mode (without bias)
- Storage of dosimetric information

Limitations of existing RADFET readout solutions

- Measuring only absorbed dose other sensors required for dose rate monitoring
- > Static radiation hardening not optimal under dynamic radiation conditions



Proposed solution: A RADFET readout system for real-time measurement of absorbed dose and dose rate with a self-adaptive multiprocessing system-on-chip

Measurement of absorbed dose and dose rate with a single RADFET

- No need for additional radiation sensors
- Simplified and cheaper design

Self-adaptive fault-tolerant multiprocessing platform

- Provides fault tolerance only when required
- Can perform additional onboard functions
- Enables high level of integration

 V_s (source)

 p^+

3. RADFET Dosimetry

Absorbed Dose Measurement

- Radiation results in charge accumulation in \geq oxide layer
- > Threshold voltage shift ΔV_{τ} increases with dose D







3. RADFET Dosimetry



Dose Rate Measurement

Radiation generates stable bulk current at medium and high dose rates (e.g. 0.65 – 32 Gy/h)

$$I = k \cdot V_{BIAS} \cdot D_R^m$$

> At lower dose rates, pulsed current is induced





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4. Rad-hard Readout System

Operating modes

- > **No readout** RADFET operates in passive mode
- > Absorbed dose readout voltage measurement
- Dose rate readout current measurement

Universal architecture

(can be applied to other sensors)





Multiprocessor System on Chip (MPSoC)

5. Analog Signal Conditioner

Voltage and current measurement

- Standard voltage amplifier for threshold voltage measurement
- Transimpedance amplifier for direct current measurement
- Charge amplifier for pulsed current measurement
- Switching between operating modes
 - Controlled by MPSoC
- Can be implemented with commercial radiation-tolerant components





5. Analog Signal Conditioner



Direct and pulsed current measurement

- > Open issues to be addressed:
 - Possible interference between the two current readout modes
 - Possible overlapping of the direct and pulsed current ranges





Main functions in readout system

- A/D conversion of DC voltage from ASC
- Counting of voltage pulses from ASC
- Control of switching matrix and amplifier gain in ASC

IHP's framework controller

- Dynamic selection of operating modes
- Trade-off between performance, fault tolerance and power consumption
- Flexible can be applied to an arbitrary number of processing cores

Radiation hardness / fault tolerance

- > IHP's 130 nm CMOS technology resistant to TID effect and Single Event Latchup (SEL)
- Core-level fault tolerance enabled with embedded SRAM acting as a particle monitor

6. Multiprocessor System-on-Chip (MPSoC)

Self-adaptive quad-core processing platform

- Dynamic selection of operating modes
 - De-stress mode : some cores are switched off
 - Fault tolerant mode: cores are set into various fault-tolerant configurations
 - High performance mode: parallel processing

Core-level fault-tolerance

- Common configurations
 - Supply voltage / frequency scaling
 - Dual Modular Redundancy (DMR)
 - Triple Modular Redundancy (TMR)
- > Use of existing on-chip resources for fault-tolerance





13



Embedded SRAM as Particle Detector

- On-chip data storage memory used also as a particle detector
- Provides information on the particle flux for triggering the fault-tolerant modes
- Flux is proportional to the number of bit errors in SRAM
- Error detection and correction (EDAC) and scrubbing logic used to detect and correct errors
- Counters store the information on the number of detected errors

Main advantage over standard SRAM-based particle monitors:

Negligible area and power overhead





Possible further work

- Validation of simultaneous measurement of direct and pulsed current
- Implementation of a complete rad-hard readout system with commercial components



Thank you for your attention!

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